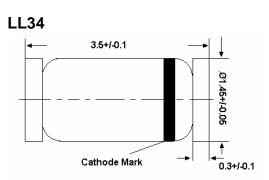
SCHOTTKY BARRIER DIODE Ultra High-Speed Switching, Voltage Clamping Protection Circuits and Blocking Applications

Features

- Low forward voltage.
- Guard ring protected.
- Hermetically-sealed leaded glass package.
- High breakdown voltage.



Glass case MiniMELF Dimensions in mm

Absolute Maximum Ratings (T_a = 25°C)

Parameter	Symbol	Limits	Unit
Continuous reverse voltage	V _R	50	V
Continuous forward current	l _F	200	mA
Average forward current	I _{F(AV)}	200	mA
Repetitive peak forward current t _p \leq 1sec.; $\delta \leq$ 0.5	I _{FRM}	500	mA
Non-repetitive peak forward current t _p =10ms	I _{FSM}	5	А
Operating ambient temperature	T _{amb}	-65 to +125	°C
Junction temperature	Tj	125	°C
Storage temperature range	Ts	-65 to +150	°C
Thermal resistance from junction to ambient	R_{thj-a}	320	K/W

Characteristics at $T_a = 25^{\circ}C$

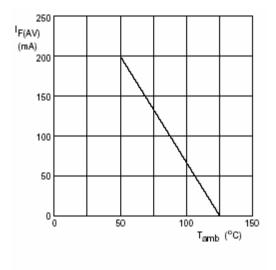
Parameter	Symbol	Min.	Тур.	Max.	Unit
Forward voltage					
at $I_F = 0.1 \text{mA}$	V_{F}	-	-	300	mV
at I _F = 1mA	V_{F}	-	-	380	mV
at I _F = 10mA	V_{F}	-	-	450	mV
at I _F = 30mA	V_{F}	-	-	600	mV
at $I_F = 100 \text{mA}$	V _F	-	-	900	mV
Reverse current (Note 1)					
at $V_R = 40V$	I _R	-	-	5	μΑ
Reverse recovery time					
at I _F = 10mA, I _R = 10mA, R _L = 100 Ω	t _{rr}	-	-	4	ns
Diode capacitance					
at $V_R = 1V$, f = 1MHz	C _d	-	-	8	pF

Note 1: Pulsed test: tp=300 μ s; δ =0.02.



SEMTECH ELECTRONICS LTD. (Subsidiary of Sino-Tech International Holdings Limited, a company listed on the Hong Kong Stock Exchange, Stock Code: 724)







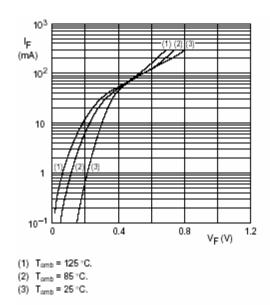
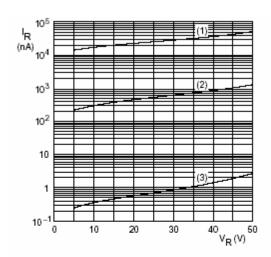
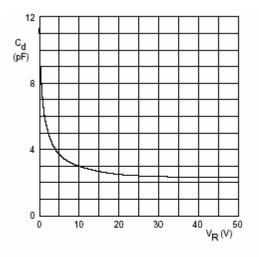


Fig. 2 Forward current as a function of forward voltage; typical values.



- (1) T_{amb} = 85 °C.
- (2) T_{amb} = 25 °C.
- (3) T_{amb} = -40 °C.
- Fig. 3 Reverse current as a function of reverse voltage; typical values.



f = 1 MHz.

Fig. 4 Diode capacitance as a function of reverse voltage; typical values.



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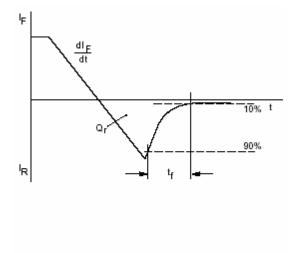


Fig. 5 Reverse recovery definitions.







Dated : 12/03/2005